	i connect CE	ors
	SPECIFICATIO	ON
宏致	電子股份有	限公司
	桃園縣中壢市東園路1	13 號
	No.13, Dongyuan Rd., Jhongl	i City,
	Taoyuan County 320, Taiwan (R.O.C.)
	TEL: +886-3-463-280 FAX: +886-3-463-180	
	0.8 mm PITCH BTB CONN	REVISION: <u>B</u>
PRODUCT NO:	50121-xxxxx-xxx series. 50122	-xxxxx-xxx series.
PREPARED:	CHECKED:	APPROVED:
FENGXIAO	DAVID	SIMON
DATE: 2014/01/18	DATE: 2014/01/18	DATE: 2014/01/18

CES	Aces F	P/N: 50121 series	
TITLE: 0.8 mm PITCH	I BTB CONN		
RELEASE DATE: 2014.01.18	REVISION: B	ECN No: ECN-1401248	PAGE: 2 OF 9
 SCOPE APPLICABLE I REQUIREMENT 	DOCUMENTS TS		4 4 4
6 INFRARED RE	FLOW CONDITION		7
		EST SEQUENCE	

Page 2

Aces P/N: 50121 series	
NN	
ECN No: ECN-1401248	PAGE: 3 OF 9
	NN

1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
0	ECN#	New drawing	Keen	08/12/17
Α	ECN-1304409	Add Gold 15u" Salt Spray	FENGXIAO	2013/04/29
В	ECN-1401248	UPDATE WORKING VOLTAGE	FENGXIAO	2014/01/18

Page 3

	Connectors	Aces F	P/N: 50121 series	
Т	ITLE: 0.8 mm PITCH	BTB CONN		
REL	EASE DATE: 2014.01.18	REVISION: B	ECN No: ECN-1401248	PAGE: 4 OF 9
2	SCOPE			
	This specification con board to board con		ests and quality requirements	for 0.8 mm pitch

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

4.1 Design and Construction

- 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
- 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)
 - Finish: (a) Contact Area: Refer to the drawing.
 - (b) Under plate: Refer to the drawing.
 - (c) Solder area: Refer to the drawing.
 - 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0

4.3 Ratings

- 4.3.1 Working Voltage Less than 36 Volts AC (per pin)
- 4.3.2 Voltage: 50 Volts AC (per pin)
- 4.3.3 Current: 0.5 Amperes (per pin)
- 4.3.4 Operating Temperature : -40°C to +85°C

 Aces P/N:
 50121 series

 TITLE:
 0.8 mm PITCH BTB CONN

 RELEASE DATE:
 2014.01.18

 REVISION:
 B

 ECN No:
 ECN-1401248

 PAGE:
 5 of 9

5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
	Product shall meet requirements of	
Examination of Product	applicable product drawing and	per applicable quality inspection
	specification.	plan.
	ELECTRICAL	
ltem	Requirement	Standard
Low Level Contact Resistance	40 m Ω Max.(initial)per contact $\triangle R$ 10 m Ω Max.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	250 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature Rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)

	MECHANICAL			
ltem	Requirement	ne tester and fully mated and nmated the number of cycles pecified at the rate of 5.4 ± 3mm/min. EIA-364-09)		
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3 mm/min. (EIA-364-09)		
Mating / Unmating Forces	Mating Force: 100 gf Max./CKT Unmating Force: 12gf Min./CTK	Operation Speed : 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13)		
Contact Retention Force	0.4kgf Min.	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with tester.		

ACES

Aces P/N: 50121 series

TITLE: 0.8 mm PITCH BTB CONN

RELEASE DATE: 2014.01.18 REVISION: B

ECN No: ECN-1401248

PAGE: 6 OF 9

	MECHANICAL					
ltem	Requirement	Standard				
Fitting Nail /Housing Retention Force	0.15kgf MIN.	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.				
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)				
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)				

	ENVIRONMENTA	L		
Item	Requirement	0~120sec. leat : 230°C Min., 40sec Min. eak Temp. : 260°C Max, 10sec Max. leflow number cycle: 2 times late module and subject to follow ondition for 5 cycles. cycles: 55 +0/-3 °C, 30 minutes		
Resistance to Reflow Soldering Heat	See Product Qualification and Test	Peak Temp.:260°∁Max,		
Thermal Shock	See Product Qualification and Test Sequence Group <mark>4</mark>	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 ℃, 30 minutes +85 +3/-0 ℃, 30 minutes (EIA-364-32, test condition I)		

Page 6

ACES

Aces P/N: 50121 series

TITLE: 0.8 mm PITCH BTB CONN

RELEASE DATE: 2014.01.18 REVISION: B

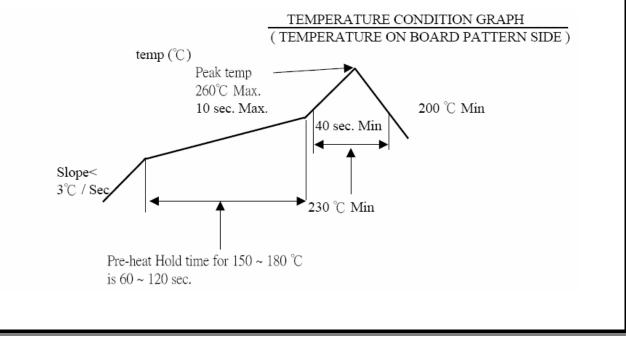
ECN No: ECN-1401248

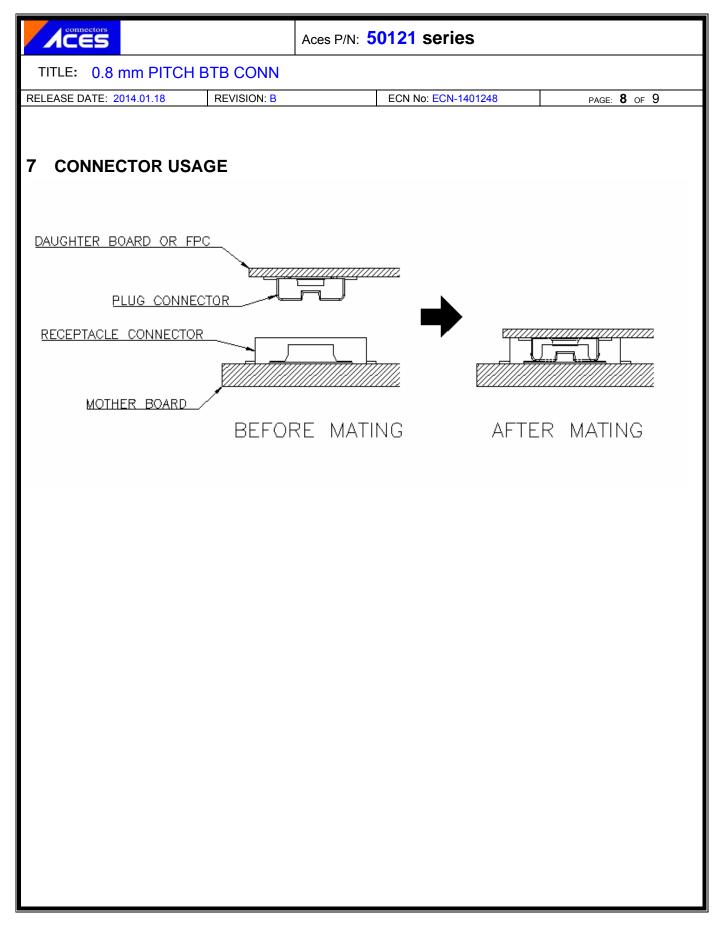
PAGE: **7** OF **9**

ENVIRONMENTAL							
ltem	Requirement	Standard					
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40℃, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)					
Temperature Life	See Product Qualification and Test Sequence Group <mark>5</mark>	Subject mated connectors to temperature life at 85℃ for 96 hours. (EIA-364-17, Test condition A)					
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group <mark>6</mark>	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 15 u" for 96 hours. (EIA-364-26)					
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)					
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.					

Note. Flowing Mixed Gas shell be conduct by customer request.

6 INFRARED REFLOW CONDITION





	Aces F	P/N: 5	012 [,]	1 ser	ries								
ITLE: 0.8 mm PITCH BTB CONN													
EASE DATE: 2014.01.18 REVISION: B			ECN	No: EC	N-1401	248			PAGE:	9 OF 9			
PRODUCT QUALIFICATION AN	ID TE	ST S	EQL	JENC	E								
					Test (Group							
Test or Examination	1	2	3	4	5	6	7	8	9	10			
				T€	est Se	quenc	e	I					
Examination of Product				1、7	1、6	1、4			1	1			
Low Level Contact Resistance		1、5	1、4	2、10	2、9	2 \ 5			3				
Insulation Resistance				3、9	3、8								
Dielectric Withstanding Voltage				4 • 8	4 \ 7								
Temperature Rise	1												
Mating / Unmating Forces		2、4											
Durability		3											
Vibration			2										
Shock (Mechanical)			3										
Thermal Shock				5									
Humidity				6									
Temperature Life					5								
Salt Spray(Only For Gold Plating)						3							
Solder ability							1						
Contact Retention Force								1					
Fitting Nail /Housing Retention Force								2					
Resistance to Soldering Heat									2				
Hand Soldering Temperature Resistance										2			
Sample Size	2	4	4	4	4	4	2	4	4	4			

单击下面可查看定价,库存,交付和生命周期等信息

>>ACES(宏致)